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NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE30P30K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is well suited for high current load applications.

General Features

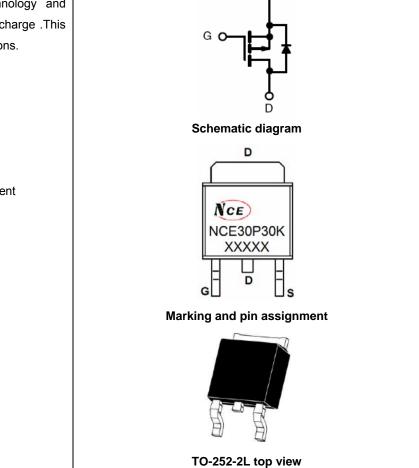
- V_{DS} =-30V,I_D =-30A
 R_{DS(ON)} <18mΩ @ V_{GS}=-10V
 R_{DS(ON)} <30mΩ @ V_{GS}=-4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- High side switch for full bridge converter
- DC/DC converter for LCD display

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

ſ	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
	NCE30P30K	NCE30P30K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	-30	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	-21.2	А
Pulsed Drain Current	I _{DM}	-120	А
Maximum Power Dissipation	PD	60	W
Derating factor		0.4	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	169	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	2.5	°C/W
	010	2.0	0/11

Electrical Characteristics (Tc=25[°]C unless otherwise noted)

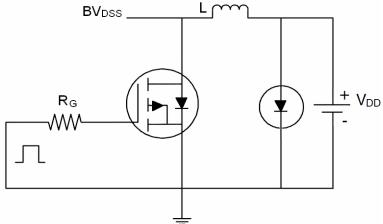
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1.2	-1.6	-2.5	V
Durain Course On Chata Desintance		V _{GS} =-10V, I _D =-20A	-	13	18	mΩ
Drain-Source On-State Resistance R _{DS}		V _{GS} =-4.5V, I _D =-15A	-	22	30	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-20A	-	25	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}		-	1363	-	PF
Output Capacitance	C _{oss}	V_{DS} =-15V, V_{GS} =0V,	-	250	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	210	-	PF
Switching Characteristics (Note 4)			ł			I.
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	tr	V_{DD} =-30V, R _L =3 Ω ,	-	10	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V,R _G =2.5Ω	-	50	-	nS
Turn-Off Fall Time	t _f		-	20	-	nS
Total Gate Charge	Qg		-	31.2		nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15,I _D =-15A,	-	3.2		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	9.2		nC
Drain-Source Diode Characteristics			1			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-15A	-		-1.2	V
Diode Forward Current (Note 2)	I _S		-	-	-20	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =- 15A	-	24		nS
Reverse Recovery Charge	Qrr	di/dt = -100A/ μ s ^(Note3)	-	16		nC

Notes:

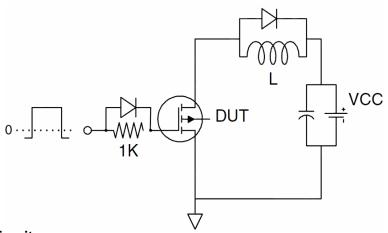
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25°C, V_{DD} =-15V, V_{G} =-10V, L=0.5mH, Rg=25 Ω , I_{AS} =-26A



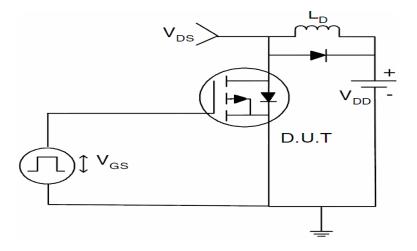
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

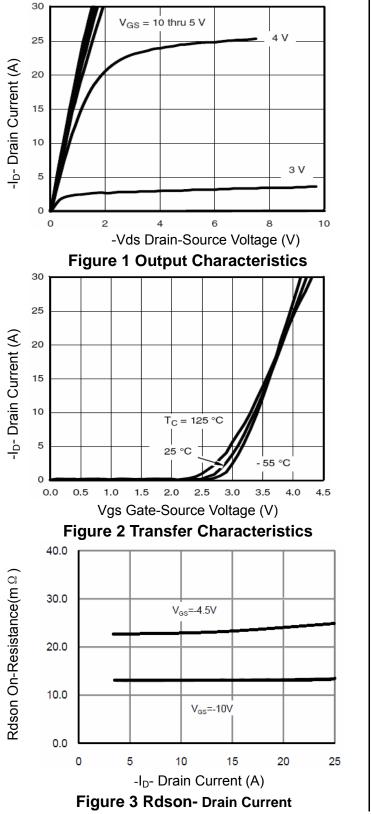


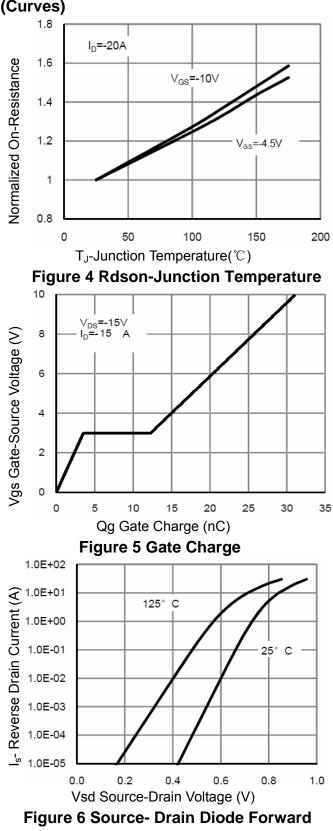
3) Switch Time Test Circuit







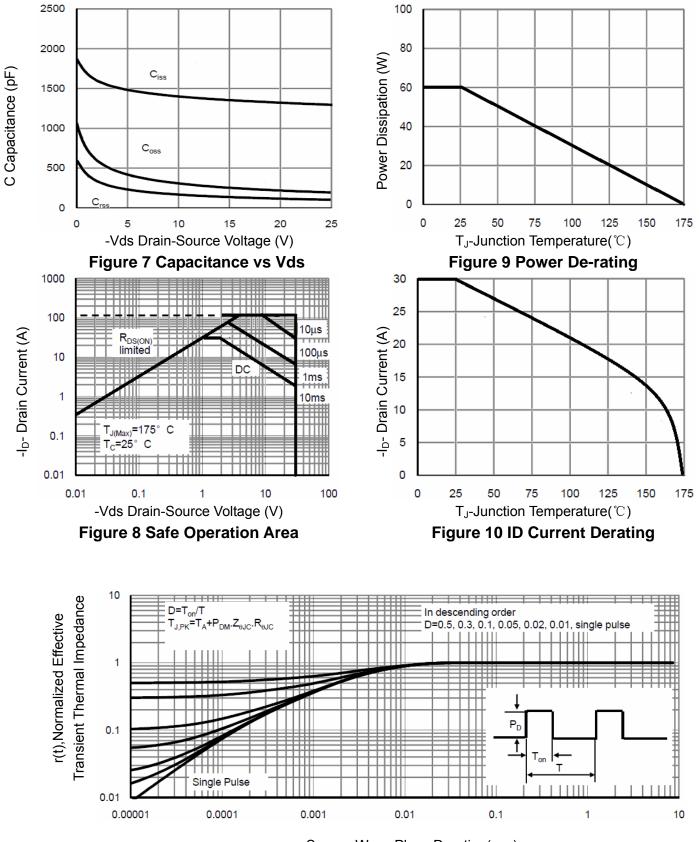






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NCE30P30K

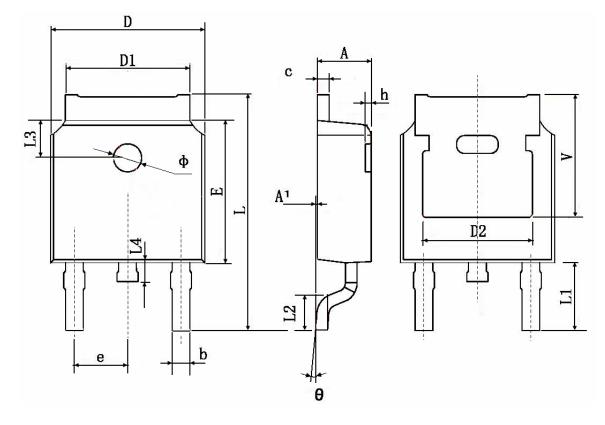


Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-252 Package Information



Querrale al	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	D TYP.	0.190) TYP.	
E	6.000	6.200	0.236	0.244	
e	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.90	D TYP.	0.114	TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.60	D TYP.	0.063	B TYP.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	D TYP.	0.211 TYP.		



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